

N-Channel Multilayer Epitaxial Super Junction Power MOSFET

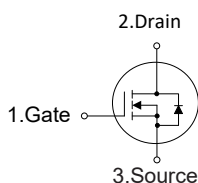
TO-220AB



TO-220F



TO-263



Features

- New technology for high voltage device
- Low on-resistance and low conduction losses
- small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

Table 1. Absolute Maximum Ratings ($T_c=25^\circ\text{C}$)

Parameter	Symbol	MCR65B260CTB MCR65B260CT	MCR65B260CTF	Unit
Drain-Source Voltage ($V_{GS}=0V$)	V_{DS}	650		V
Gate-Source Voltage ($V_{DS}=0V$), AC($f>1HZ$)	V_{GS}	± 30		V
Continuous Drain Current at $T_C=25^{\circ}C$	I_D (DC)	15	15*	A
Continuous Drain Current at $T_C=100^{\circ}C$	I_D (DC)	9	9*	A
Pulsed drain current (Note 1)	I_{DM} (pluse)	45	45*	A
Maximum Power Dissipation($T_C=25^{\circ}C$)	P_D	101	32.6	W
Single pulse avalanche energy (Note2)	E_{AS}	290		mJ
Avalanche current (Note 1)	I_{AR}	2.4		A
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	E_{AR}	0.44		mJ
Drain Source voltage slope, $V_{DS} \leq 480 V$,	dv/dt	50		V/ns
Reverse diode dv/dt , $V_{DS} \leq 480 V, I_{SD} < I_D$	dv/dt	15		V/ns
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~+150		$^{\circ}C$
* limited by maximum junction temperature				

Table 2. Thermal Characteristic

Parameter	Symbol	MCR65B260CTB MCR65B260CT	MCR65B260CTF	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R_{thJC}	1.24	3.83	$^{\circ}\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient (Maximum)	R_{thJA}	62	80	$^{\circ}\text{C}/\text{W}$

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			100	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250μA	2.5		4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =5.3A		240	260	mΩ
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =100V,V _{GS} =0V, F=1.0MHz		1139		pF
Output Capacitance	C _{oss}			40		pF
Reverse Transfer Capacitance	C _{rss}			3		pF
Total Gate Charge	Q _g	V _{DS} =520V,I _D =15A , V _{GS} =10V		27		nC
Gate-Source Charge	Q _{gs}			5.5		nC
Gate-Drain Charge	Q _{gd}			10.5		nC
Switching times						
Turn-on Delay Time	t _{d(on)}	V _{DD} =400V,I _D =15A , R _G =25Ω		25		nS
Turn-on Rise Time	t _r			63		nS
Turn-Off Delay Time	t _{d(off)}			100		nS
Turn-Off Fall Time	t _f			50		nS
Source- Drain Diode Characteristics						
Forward on voltage	V _{SD}	Tj=25℃,I _{SD} =15A,V _{GS} =0V		0.9	1.2	V
Reverse Recovery Time	t _{rr}	VR=400V,I _F =Is, di/dt=100A/μs		410		nS
Reverse Recovery Charge	Q _{rr}			4.1		uC
Peak Reverse Recovery Current	I _{rrm}			20		A

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. $T_J=25^{\circ}\text{C}, V_{DD}=50V, V_G=10V, R_G=25\Omega$

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Output Characteristics

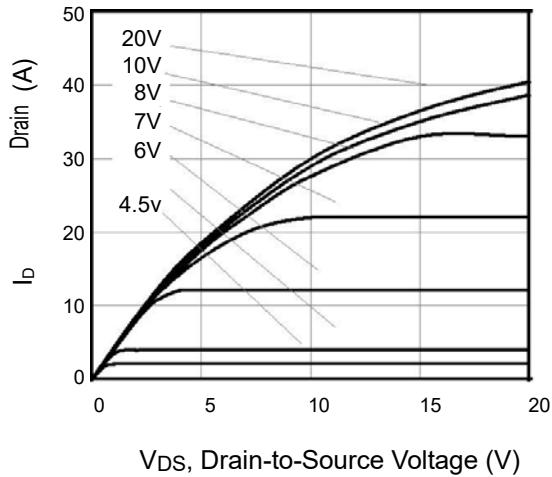


Figure 2. Transfer Characteristics

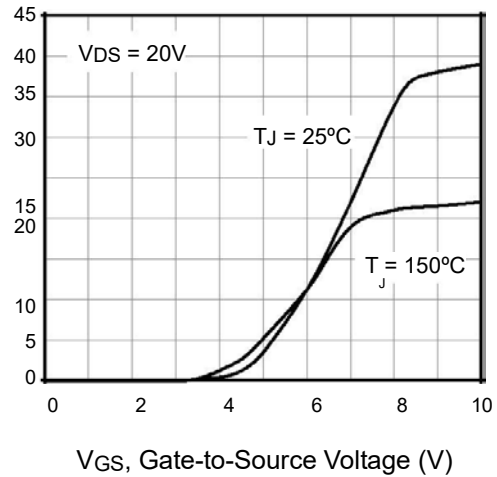


Figure 3. On-Resistance vs. Drain Current

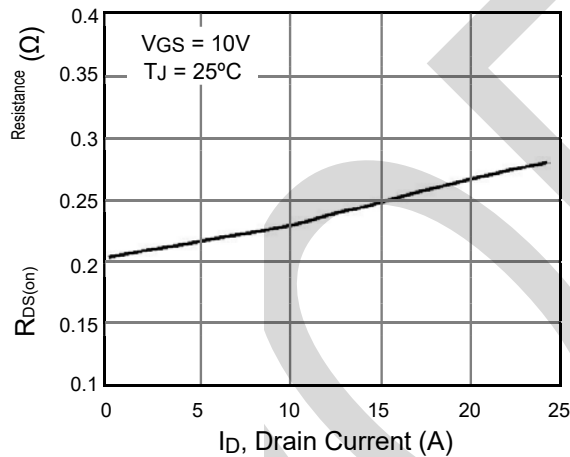


Figure 4. Capacitance

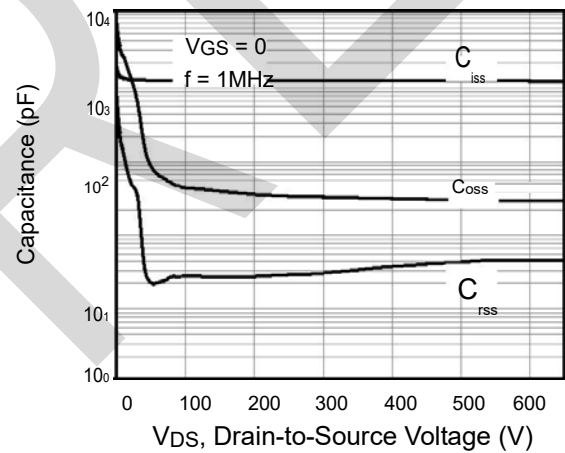


Figure 5. Gate Charge

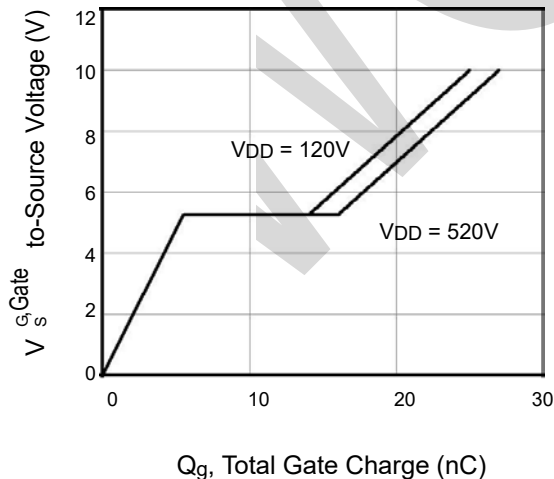
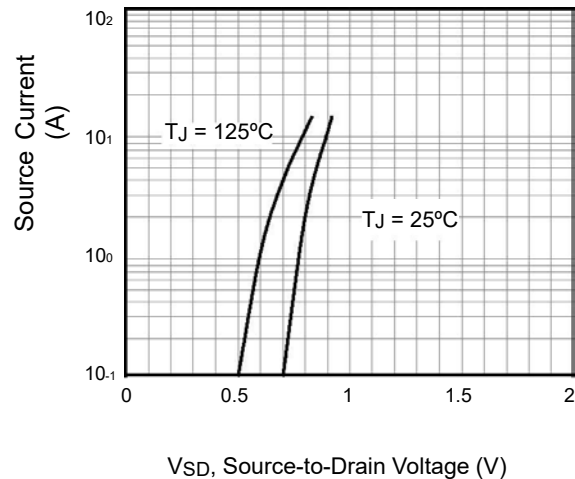


Figure 6. Body Diode Forward Voltage



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 7. On-Resistance vs. Junction Temperature

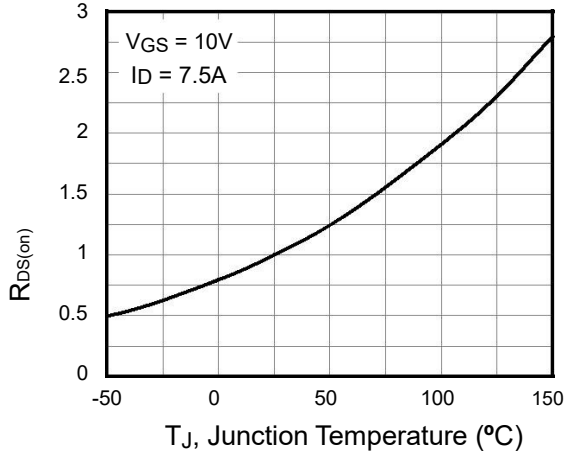


Figure 8. Breakdown voltage vs. Junction Temperature

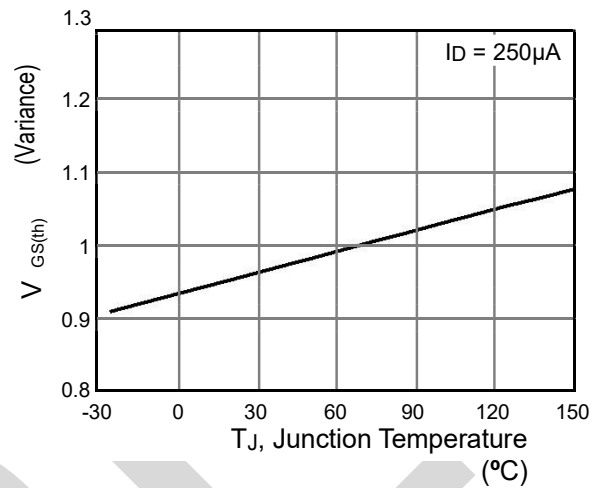


Figure 9. Transient Thermal Impedance

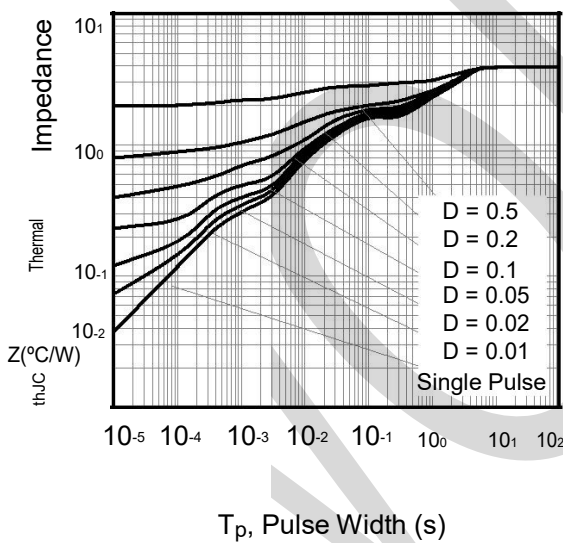
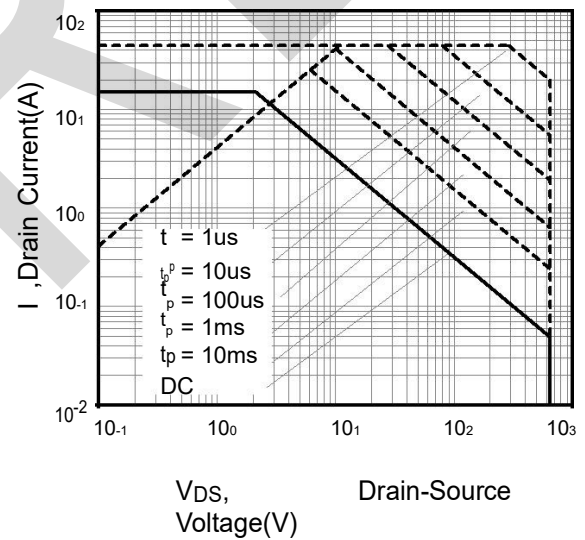
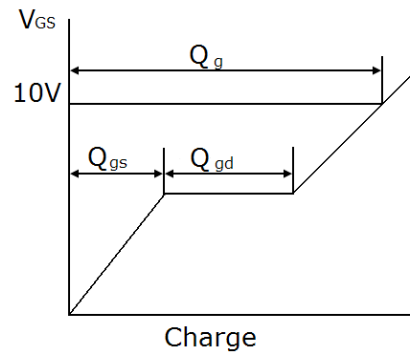
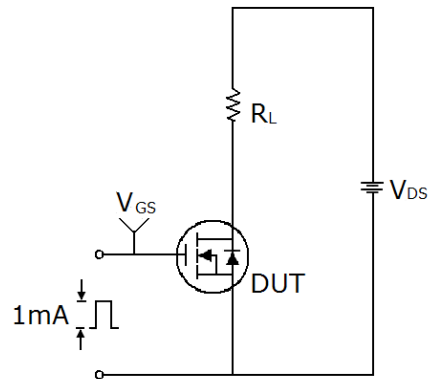


Figure 10. Safe operation area for

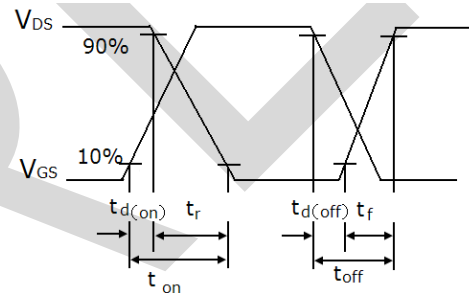
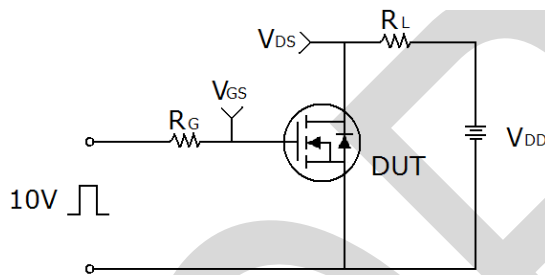


Test circuit

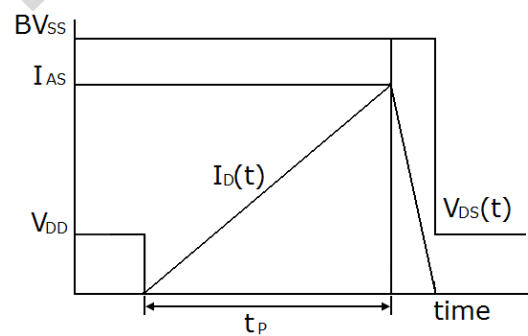
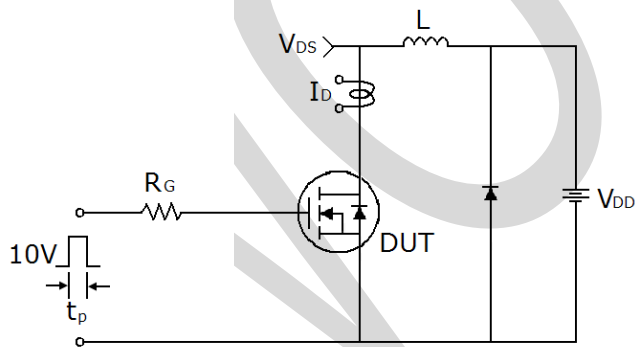
1) Gate charge test circuit & Waveform



2) Switch Time Test Circuit:

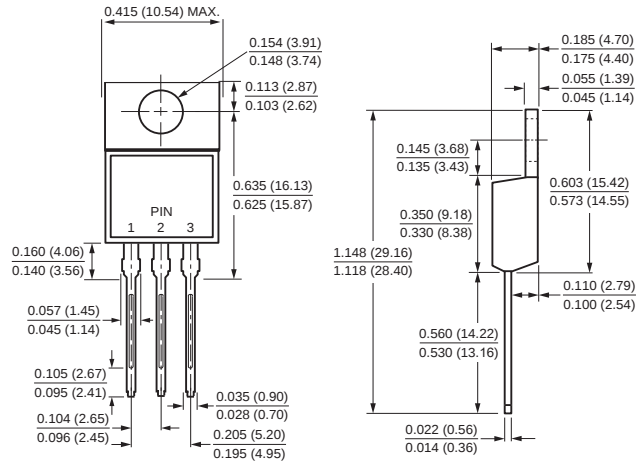


3) Unclamped Inductive Switching Test Circuit & Waveforms

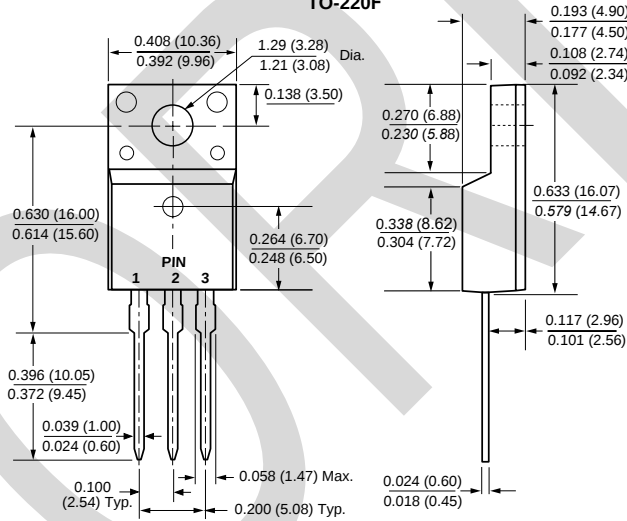


PACKAGE OUTLINE DIMENSIONS

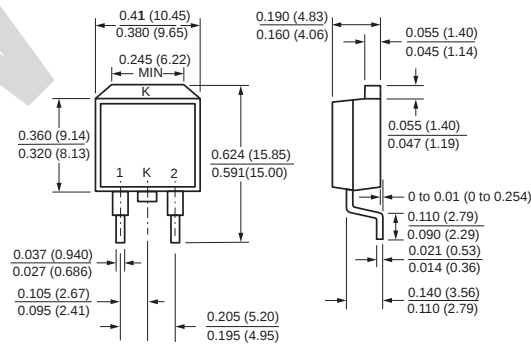
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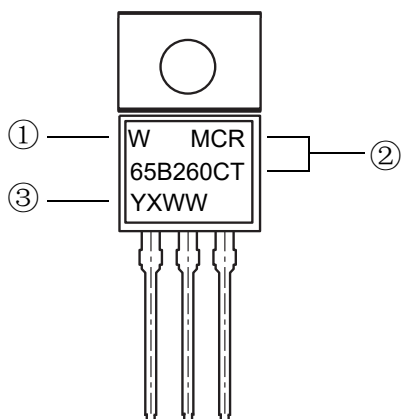
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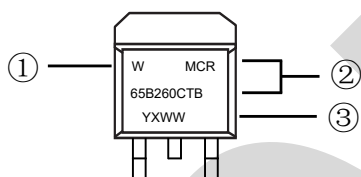
Marking Information



- ①W : Company's trademark
- ②Product model : MCR65B260CT/CTF
- ③PDC information :

Y X WW

- WW:Week code(01 to 53)
- X:Internal identification code
- Y:Year code(ex:0=2020)



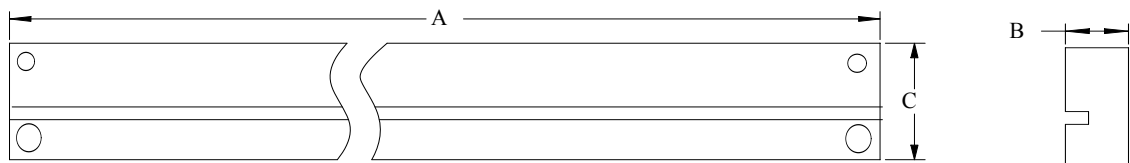
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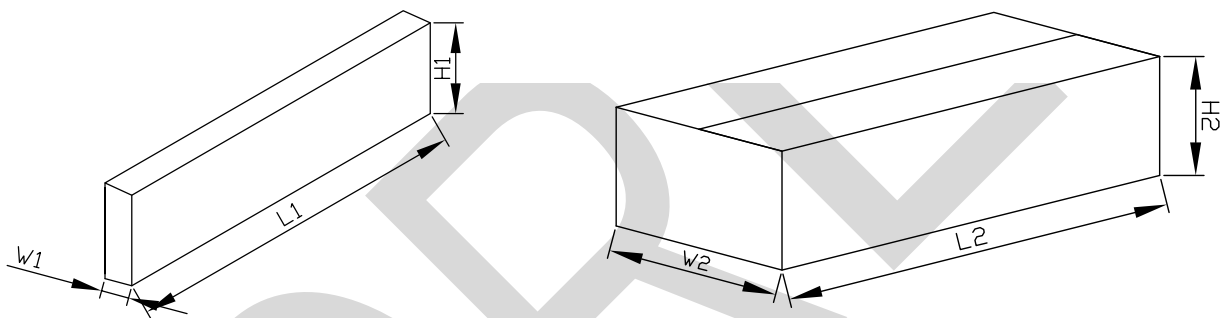
Packaging Information

1. Tube Dimensions



2. Inside Box

3. Outside Box



Packaging Information

NO	UNIT	Tube Dimensions			Inside Box			Outside Box		
Size	mm	A	B	C	L1	W1	H1	L2	W2	H2
		530	7	32	573	50	160	590	285	185
QTY	PCS	50PCS/Tube			Smallest package,1000PCS, 20 tube in total			5,000PCS/carton,5 boxes in total		
Note	Tolerance ≤20mm,±3mm; 21-100mm,±5mm; 101-500mm,±10mm									